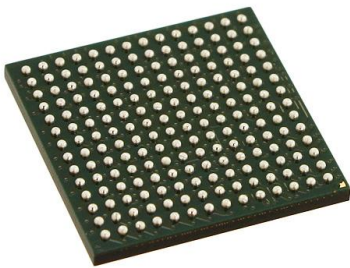


XC56309VF100AR2 Datasheet

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DiGi Electronics Part Number	XC56309VF100AR2-DG
Manufacturer	NXP USA Inc.
Manufacturer Product Number	XC56309VF100AR2
Description	IC DSP 24BIT 100MHZ 196-MABGA
Detailed Description	Embedded, Integrated Circuits (ICs)

This model XC56309VF100AR2 is available at DiGi Electronics.

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Manufacturer Product Number:

XC56309VF100AR2

Series:

DSP563xx

Type:

Fixed Point

Clock Rate:

100MHz

On-Chip RAM:

24kB

Voltage - Core:

3.30V

Mounting Type:

Surface Mount

Supplier Device Package:

196-LBGA (15x15)

Manufacturer:

NXP USA Inc.

Product Status:

Obsolete

Interface:

Host Interface, SSI, SCI

Non-Volatile Memory:

ROM (576B)

Voltage - I/O:

3.30V

Operating Temperature:

-40°C ~ 105°C (TJ)

Package / Case:

196-LBGA

Base Product Number:

XC56

Environmental & Export classification

RoHS Status:

RoHS non-compliant

REACH Status:

REACH Unaffected

HTSUS:

8542.31.0001

Moisture Sensitivity Level (MSL):

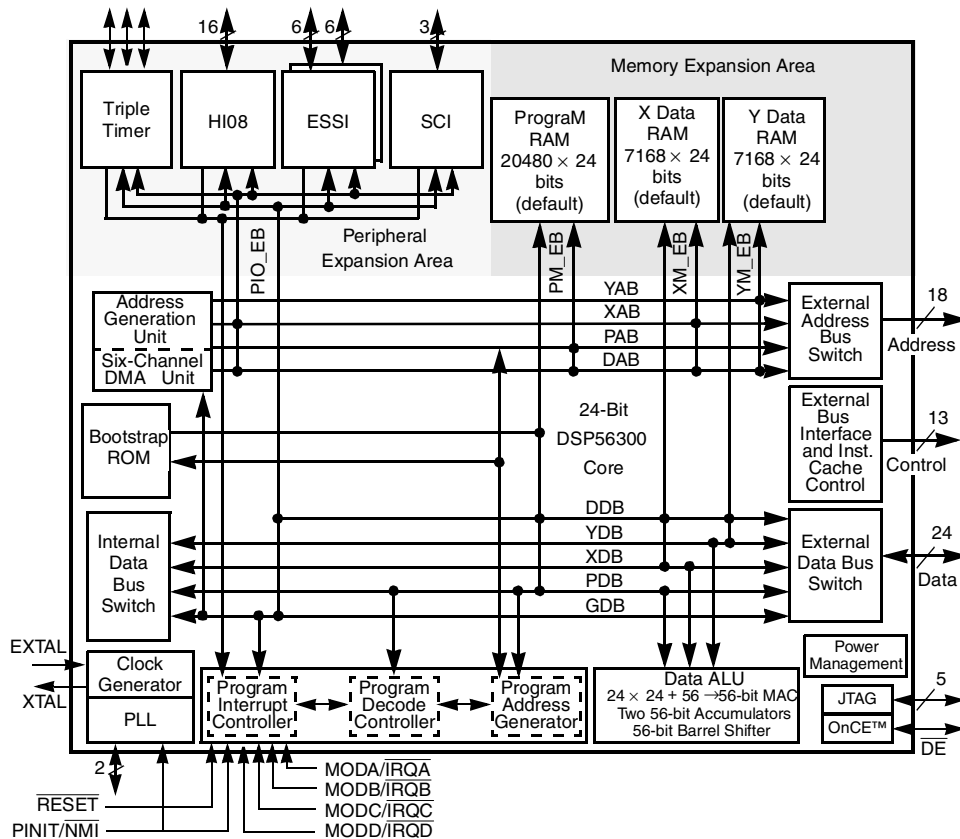
3 (168 Hours)

ECCN:

3A991A2

DSP56309

24-Bit Digital Signal Processor



The DSP56309 is intended for applications benefiting from a large amount of internal memory, such as wireless infrastructure applications.

Figure 1. DSP56309 Block Diagram

The DSP56309 is a member of the DSP56300 core family of programmable CMOS DSPs. The DSP56300 core includes a barrel shifter, 24-bit addressing, an instruction cache, and direct memory access (DMA). The DSP56309 offers 100 million multiply-accumulates per second (MMACS) at 3.0–3.6 V using an internal 100 MHz clock. The large internal memory is ideal for wireless infrastructure and wireless local-loop applications. The DSP56300 core family offers a new level of performance in speed and power provided by its rich instruction set and low-power dissipation, thus enabling a new generation of wireless, multimedia, and telecommunications products.

Note: This document contains information on a new product. Specifications and information herein are subject to change without notice.

Features

Table 1 lists the features of the DSP56309 device.

Table 1. DSP56309 Features

Feature	Description																														
High-Performance DSP56300 Core	<ul style="list-style-type: none"> • 100 million multiply-accumulates per second (MMACS) with a 100 MHz clock at 3.3 V nominal • Data arithmetic logic unit (Data ALU) with fully pipelined 24 × 24-bit parallel multiplier-accumulator (MAC), 56-bit parallel barrel shifter (fast shift and normalization; bit stream generation and parsing), conditional ALU instructions, and 24-bit or 16-bit arithmetic support under software control • Program control unit (PCU) with position-independent code (PIC) support, addressing modes optimized for DSP applications (including immediate offsets), internal instruction cache controller, internal memory-expandable hardware stack, nested hardware DO loops, and fast auto-return interrupts • Direct memory access (DMA) with six DMA channels supporting internal and external accesses; one-, two- and three-dimensional transfers (including circular buffering); end-of-block-transfer interrupts; and triggering from interrupt lines and all peripherals • Phase-lock loop (PLL) allows change of low-power divide factor (DF) without loss of lock and output clock with skew elimination • Hardware debugging support including on-chip emulation (OnCE) module, Joint Test Action Group (JTAG) test access port (TAP) 																														
Internal Peripherals	<ul style="list-style-type: none"> • Enhanced 8-bit parallel host interface (HI08) supports a variety of buses (for example, ISA) and provides glueless connection to a number of industry-standard microcomputers, microprocessors, and DSPs • Two enhanced synchronous serial interfaces (ESSI), each with one receiver and three transmitters (allows six-channel home theater) • Serial communications interface (SCI) with baud rate generator • Triple timer module • Up to thirty-four programmable general-purpose input/output (GPIO) pins, depending on which peripherals are enabled 																														
Internal Memories	<ul style="list-style-type: none"> • 192 × 24-bit bootstrap ROM • 8 K × 24-bit RAM total • Program RAM, instruction cache, X data RAM, and Y data RAM sizes are programmable: <table border="1"> <thead> <tr> <th>Program RAM Size</th> <th>Instruction Cache Size</th> <th>X Data RAM Size</th> <th>Y Data RAM Size</th> <th>Instruction Cache</th> <th>Switch Mode</th> </tr> </thead> <tbody> <tr> <td>20480 × 24 bits</td> <td>0</td> <td>7168 × 24 bits</td> <td>7168 × 24 bits</td> <td>disabled</td> <td>disabled</td> </tr> <tr> <td>19456 × 24 bits</td> <td>1024 × 24-bit</td> <td>7168 × 24 bits</td> <td>7168 × 24 bits</td> <td>enabled</td> <td>disabled</td> </tr> <tr> <td>24576 × 24 bits</td> <td>0</td> <td>5120 × 24 bits</td> <td>5120 × 24 bits</td> <td>disabled</td> <td>enabled</td> </tr> <tr> <td>23552 × 24 bits</td> <td>1024 × 24-bit</td> <td>5120 × 24 bits</td> <td>5120 × 24 bits</td> <td>enabled</td> <td>enabled</td> </tr> </tbody> </table>	Program RAM Size	Instruction Cache Size	X Data RAM Size	Y Data RAM Size	Instruction Cache	Switch Mode	20480 × 24 bits	0	7168 × 24 bits	7168 × 24 bits	disabled	disabled	19456 × 24 bits	1024 × 24-bit	7168 × 24 bits	7168 × 24 bits	enabled	disabled	24576 × 24 bits	0	5120 × 24 bits	5120 × 24 bits	disabled	enabled	23552 × 24 bits	1024 × 24-bit	5120 × 24 bits	5120 × 24 bits	enabled	enabled
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External Memory Expansion	<ul style="list-style-type: none"> • Data memory expansion to two 256 K × 24-bit word memory spaces using the standard external address lines • Program memory expansion to one 256 K × 24-bit words memory space using the standard external address lines • External memory expansion port • Chip select logic for glueless interface to static random access memory (SRAMs) • Internal DRAM Controller for glueless interface to dynamic random access memory (DRAMs) 																														
Power Dissipation	<ul style="list-style-type: none"> • Very low-power CMOS design • Wait and Stop low-power standby modes • Fully static design specified to operate down to 0 Hz (dc) • Optimized power management circuitry (instruction-dependent, peripheral-dependent, and mode-dependent) 																														
Packaging	<ul style="list-style-type: none"> • 144-pin TQFP package in lead-free or lead-bearing versions • 196-pin molded array plastic-ball grid array (MAP-BGA) package in lead-free or lead-bearing versions 																														

Target Applications

The DSP56309 is intended for applications benefiting from a large amount of internal memory, such as wireless infrastructure applications.

Product Documentation

The documents listed in **Table 2** are required for a complete description of the DSP56309 device and are necessary to design properly with the part. Documentation is available from a local Freescale distributor, a Freescale semiconductor sales office, or a Freescale Semiconductor Literature Distribution Center. For documentation updates, visit the Freescale DSP website. See the contact information on the back cover of this document.

Table 2. DSP56309 Documentation

Name	Description	Order Number
<i>DSP56309 Technical Data</i>	Description, features list, and specifications of the DSP56309	DSP56309
<i>DSP56309 User's Manual</i>	Detailed functional description of the DSP56309 memory configuration, operation, and register programming	DSP56309UM
<i>DSP56300 Family Manual</i>	Detailed description of the DSP56300 family processor core and instruction set	DSP56300FM
Application Notes	Documents describing specific applications or optimized device operation including code examples	See the DSP56309 product website

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DSP56309PB
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